TOSHIBA FIELD EFFECT TRANSISTOR SILICON P CHANNEL MOS TYPE (U-MOSⅡ)

TPC8305

LITHIUM ION BATTERY

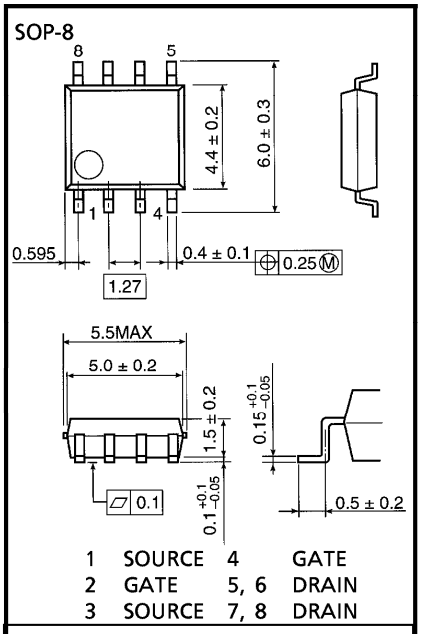
NOTE BOOK PC

PORTABLE MACHINES AND TOOLS

INDUSTRIAL APPLICATIONS

- Compact and thin package allows smaller mounting area.
- Low Drain-Source ON Resistance : $R_{DS\,(ON)} = 24\,m\Omega$ (Typ.)
- High Forward Transfer Admittance : $|Y_{fs}| = 12\,S$ (Typ.)
- Low Leakage Current : $I_{DSS} = -10\,\mu A$ (Max.) ($V_{DS} = -20\,V$)
- Enhancement-Mode : $V_{th} = -0.5 \sim -1.2\,V$ ($V_{DS} = -10\,V$, $I_D = -1\,mA$)

Unit in mm

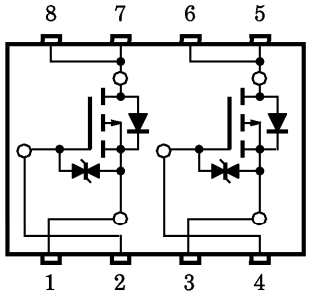


JEDEC	—
EIAJ	—
TOSHIBA	2-6J1A

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DSS}	−20	V
Drain-Gate Voltage ($R_{GS} = 20\,k\Omega$)		V_{DGR}	−20	V
Gate-Source Voltage		V_{GSS}	±12	V
Drain Current	DC	I_D	−5	A
	Pulse	I_{DP}	−20	A
Drain Power Dissipation*** (Ta = 25°C)		P_D	2.0	W
Single Pulse Avalanche Energy**		E_{AS}	32.5	mJ
Avalanche Current		I_{AR}	−5	A
Repetitive Avalanche Energy*		E_{AR}	0.2	mJ
Channel Temperature		T_{ch}	150	°C
Storage Temperature Range		T_{stg}	−55~150	°C

CIRCUIT CONFIGURATION



THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Ambient***	$R_{th\,(ch\text{-}a)}$	62.5	°C / W

Note ;

* Repetitive rating ; Pulse Width Limited by Max. Junction temperature.

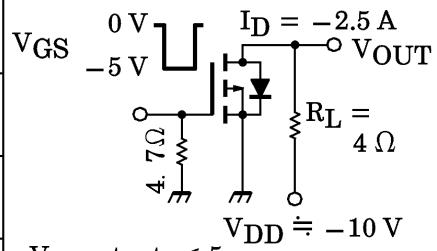
** $V_{DD} = -16\,V$, $T_{ch} = 25°C$ (initial), $L = 1.0\,mH$, $R_G = 25\,\Omega$, $I_{AR} = -5\,A$

*** Drive operation ; Mount on glass epoxy board [$1inch^2 \times 0.8\,t$] in the two devices driving ($t = 10\,s$)

This transistor is an electrostatic sensitive device. Please handle with caution.

961001EAA1

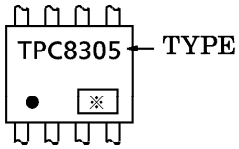
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I_{GSS}	$V_{GS} = \pm 10$ V, $V_{DS} = 0$ V	—	—	±10	μA
Drain Cut-Off Current		I_{DSS}	$V_{DS} = -20$ V, $V_{GS} = 0$ V	—	—	−10	μA
Drain-Source Breakdown Voltage		$V_{(BR)\,DSS}$	$I_D = -10$ mA, $V_{GS} = 0$ V	−20	—	—	V
			$I_D = -10$ mA, $V_{GS} = 12$ V	−8	—	—	
Gate Threshold Voltage		V_{th}	$V_{DS} = -10$ V, $I_D = -200$ μA	−0.5	—	−1.2	V
Drain-Source ON Resistance		$R_{DS\,(ON)}$	$V_{GS} = -2.0$ V, $I_D = -2.5$ A	—	56	80	mΩ
		$R_{DS\,(ON)}$	$V_{GS} = -2.5$ V, $I_D = -2.5$ A	—	38	50	mΩ
		$R_{DS\,(ON)}$	$V_{GS} = -4.5$ V, $I_D = -2.5$ A	—	24	30	mΩ
Forward Transfer Admittance		$\|Y_{fs}\|$	$V_{DS} = -10$ V, $I_D = -2.5$ A	6	12	—	S
Input Capacitance		C_{iss}	$V_{DS} = -10$ V, $V_{GS} = 0$ V, f = 1 MHz	—	2030	—	pF
Reverse Transfer Capacitance		C_{rss}		—	400	—	
Output Capacitance		C_{oss}		—	580	—	
Switching Time	Rise Time	t_r		—	25	—	ns
	Turn-On Time	t_{on}		—	35	—	
	Fall Time	t_f		—	95	—	
	Turn-Off Time	t_{off}		—	200	—	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Q_g	$V_{DD} \fallingdotseq -16$ V, $V_{GS} = -5$ V, $I_D = -5$ A	—	24	—	nC
Gate-Source Charge		Q_{gs}		—	17	—	
Gate-Drain ("Miller") Charge		Q_{gd}		—	7	—	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I_{DR}	—	—	—	−5	A
Pulse Drain Reverse Current	I_{DRP}	—	—	—	−20	A
Diode Forward Voltage	V_{DSF}	$I_{DR} = -5$A, $V_{GS} = 0$V	—	—	1.2	V

MARKING

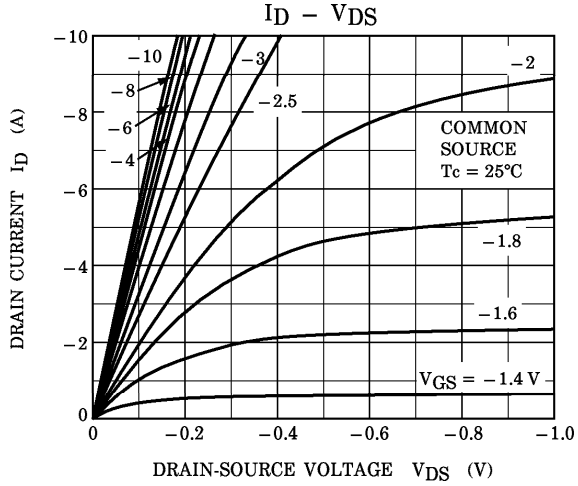


※ Lot Number

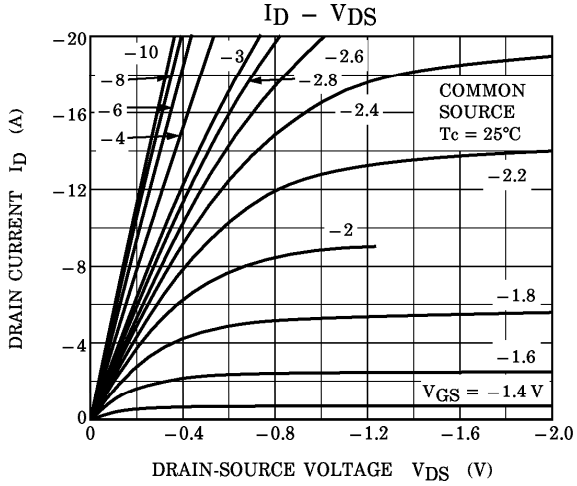
□□ — Month (Starting from Alphabet A)

— Year (Last Number of the Christian Era)

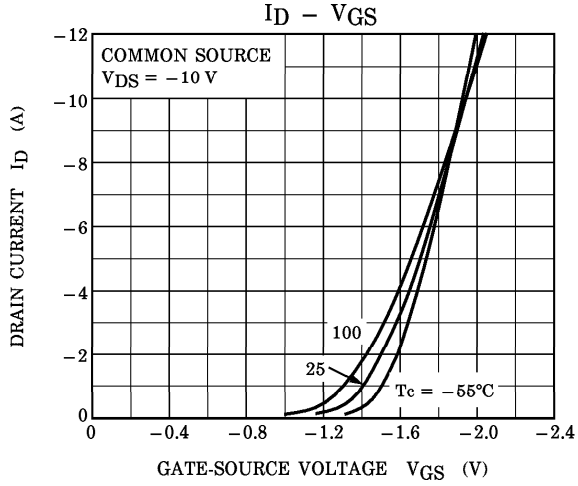
$I_D - V_{DS}$



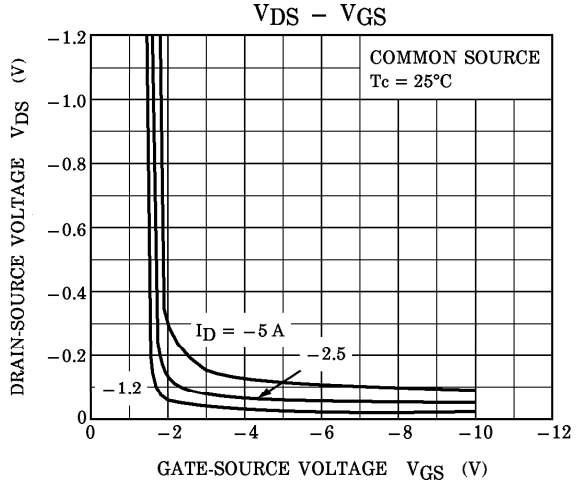
$I_D - V_{DS}$



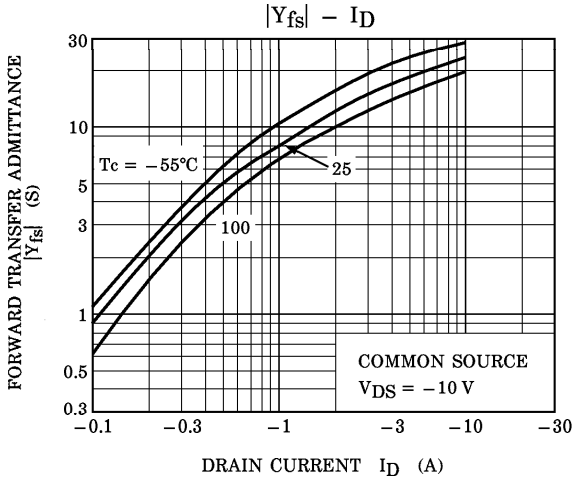
$I_D - V_{GS}$



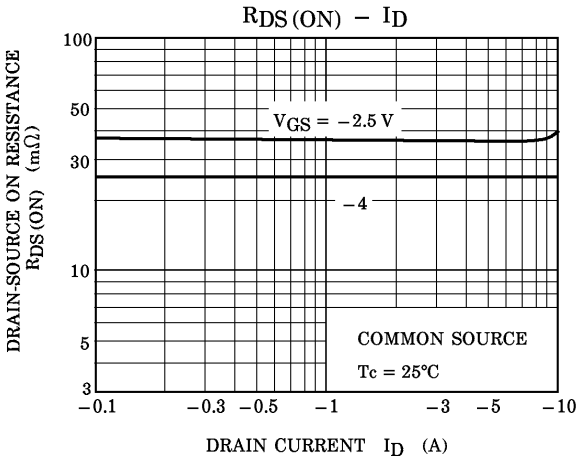
$V_{DS} - V_{GS}$



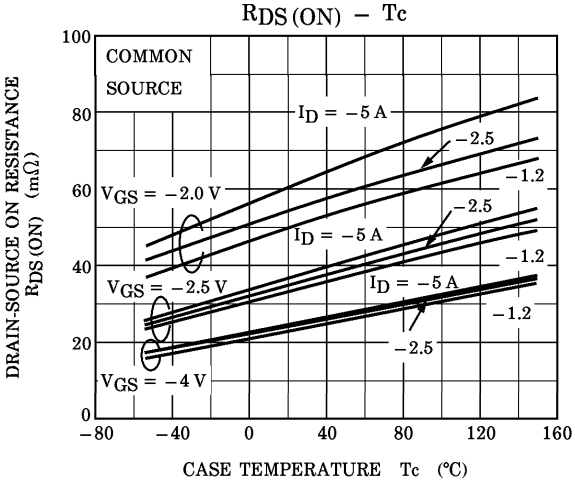
$|Y_{fs}| - I_D$



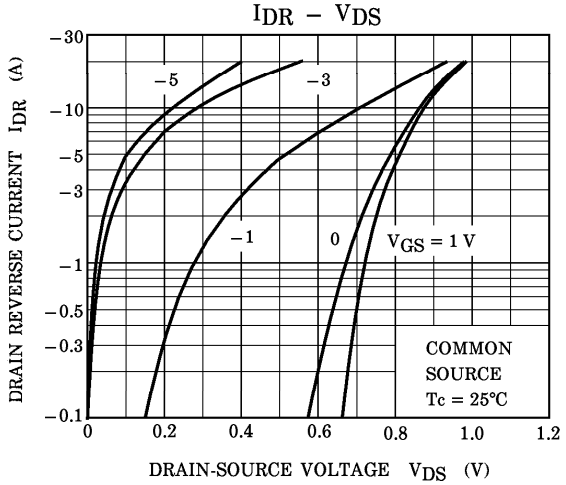
$R_{DS\,(ON)} - I_D$



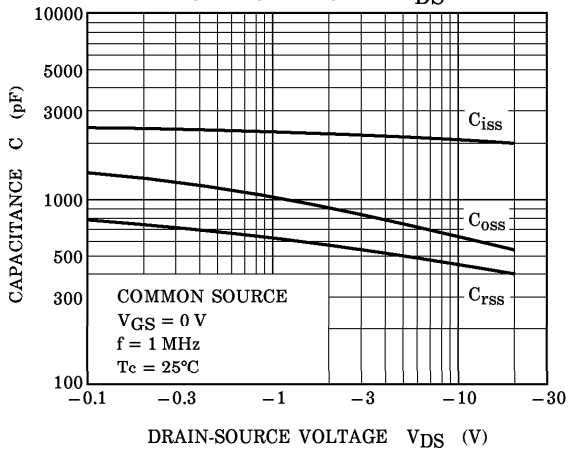
$R_{DS\,(ON)}$ – Tc



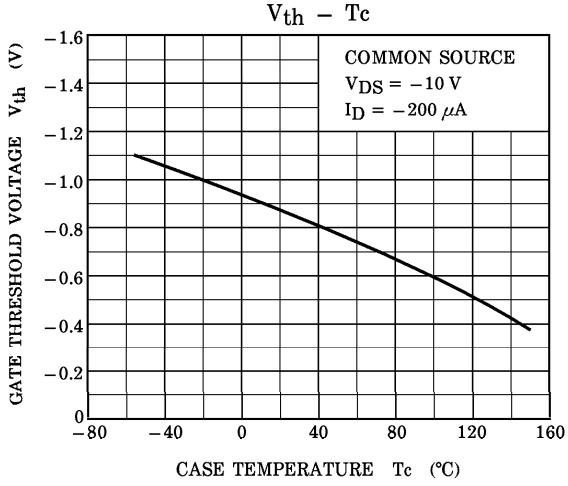
I_{DR} – V_{DS}



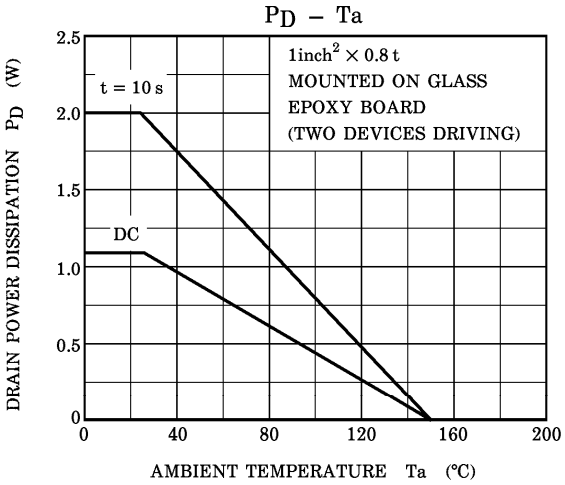
CAPACITANCE – V_{DS}



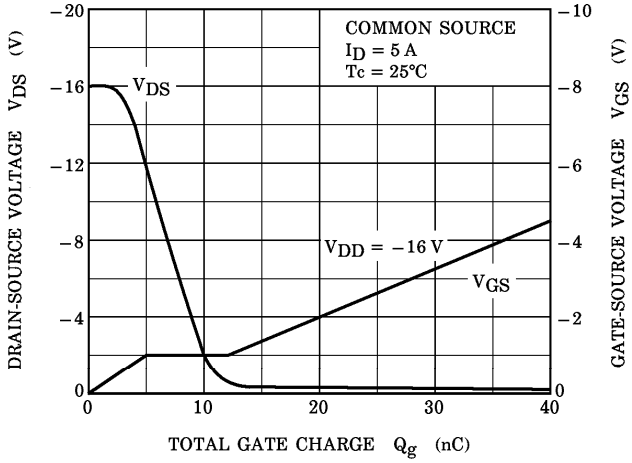
V_{th} – Tc



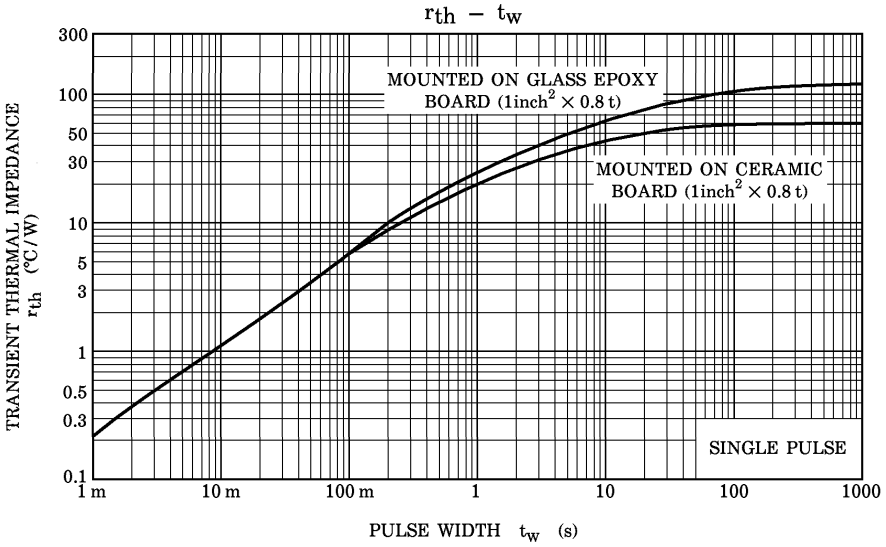
P_D – Ta



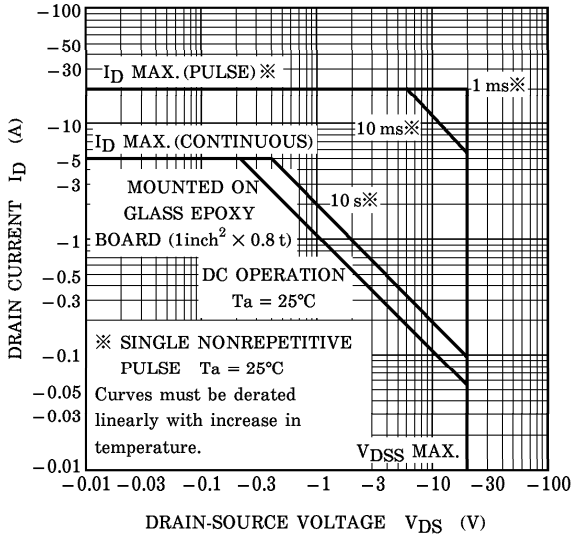
DYNAMIC INPUT / OUTPUT CHARACTERISTICS



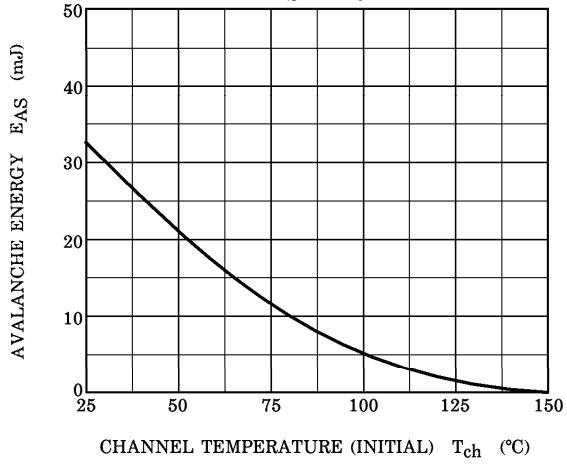
r_{th} – t_w

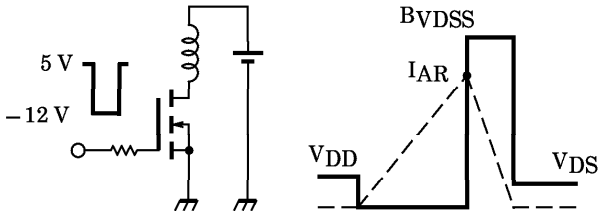


SAFE OPERATING AREA



E_{AS} – T_{ch}





TEST CIRCUIT WAVE FORM

Peak I_{AR} = −5 A, R_G = 25 Ω
V_{DD} = −16 V, L = 1.0 mH

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$